

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.: 5051-603 DATE: February 22, 2002



UTILITY PATENT APPLICATION TRANSMITTAL LETTER AND FEE TRANSMITTAL FORM (37 CFR 1.53(b))

BOX PATENT APPLICATION Assistant Commissioner for Patents Washington, DC 20231 Sir: Transmitted herewith for filing under 37 CFR 1.53(b) is: a patent application a Divisional a Continuation-in-Part (CIP) Application of prior a Continuation Half Half Half application no.:______; filed ______, the disclosure of which is hereby incorporated herein by reference in its entirety. and claims the benefit of Provisional Application No. _____; filed _____. T) Inventor(s) or Application Identifier: Veena Misra, Huicai Zhong, ShinNam Hong Z. Entitled: HIGH/LOW WORK FUNCTION METAL ALLOYS FOR INTEGRATED CIRCUIT T. ELECTRODES AND METHODS OF FABRICATING SAME But to T. **Correspondence Address:** Enclosed are: 1. Application Transmittal Letter and Fee Transmittal Form (A duplicate is enclosed for fee processing) 23 pages of Specification (including 38 claims) 3. X 11 sheets of Formal Drawings (35 USC 113) 4. Oath or Declaration a. newly executed (original or copy) copy from prior application (37 CFR 1.63(d) (for continuation/divisional) [Note Box 6 Below] DELETION OF INVENTOR(S) (Signed statement deleting inventor(s) named in the prior application) Application Data Sheet. See 37 CFR 1.76 Incorporation By Reference (useable if box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein. 7. Microfiche Computer Program (Appendix) Assignment papers (cover sheet(s) and document(s))

Applicant claims small entity status. See 37 CFR 1.27.

10. Information Disclosure S	Statement, PTO-1449,	and	references cited	
11. Preliminary Amendment	(Please enter all clair	n amendn	- nents prior to calculating the filing	fee.)
12. English Translation Doc	ument			
13. Certified Copy of	Application No.	; Filed		
14. Sequence Listing/ Seque	nce Listing Diskette			
a. computer readable copy				
b. paper copy				
 c. statement in support 				
15. An Associate Power of A	Attorney			
16. Return Receipt Postcard	(MPEP 503) (Should be	specifically	itemized)	
17. Other: Application Filed	1 Under 37 CFR 1.41(c	:)		
The fee has been calculated as s	hown below:	-		

		No. Filed	No. Extra	Rate	Fee	Rate	Fee				
	BASIC FEE			\$370.00		\$ 740.00					
** .	TOTAL CLAIMS	38 - 20 =	18	x 09 = \$		x 18 = \$324.00					
	INDEP CLAIMS	2 - 3 =		x 42 = \$		x 84 =	\$				
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T. T.	If the difference in Col. 1 is	Total \$		Total	\$1064.00						
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	A check in the amount of \$\\$ is enclosed to cover the filing fee, PLUS the Assignment										
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\$10E	Recordation fee (\$40.00). Please charge my Deposit Account No. 50-0220 in the amount of \$. The Commissioner is hereby authorized to credit overpayments or charge the following fees										
The Commissioner is hereby authorized to credit overpayments or charge the following fees											
350	associated with this communication to Deposit Account No. 50-0220:										
	a. Additional filing fees under 37 CFR 1.16 for presentation of extra claims.										
	b. Additional patent application processing fees under 37 CFR 1.17.										

Column 2

Column 1

Respectfully submitted,

Small Entity

Large Entity

Mitchell S. Bigel
Registration No. 29,614

Correspondence Address:

20792

PATENT TRADEMARK OFFICE

CERTIFICATE OF EXPRESS MAILING

Express Mail Label No. EL 920740535 US

Date of Deposit: February 22, 2002

I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to: BOX PATENT APPLICATION, Commissioner for Patents, Washington, DC 20231.

Susan E. Freedman

Date of Signature: February 22, 2002